



CERTIFICATE OF COMPLIANCE - Packaging and Packaging Waste Declaration -

NXP Semiconductors Netherlands B.V. certifies that, to its best knowledge, the packaging materials of NXP semiconductor products are designated to be:

- Packaging and Packaging Waste (PPW) compliant (this includes all primary packaging of individual products, secondary packaging for grouped products, and tertiary packaging for shipping and handling during transport of products) and meet the requirements of the EU-Directive 94/62/EC (Packaging and Packaging Waste, PPW) and its amendments.

Where the packaging materials used meets the essential requirements:

1. The packaging volume and weight are limited to the minimum amount necessary to maintain safety, hygiene, and acceptance of the packaged semiconductor devices;
2. Packaging materials are manufactured to permit reuse or recovery when disposed of;
3. Noxious and hazardous substances are minimized when packaging is incinerated or landfilled; and
4. Heavy metals (lead, cadmium, mercury and hexavalent chromium) are prohibited and do not exceed the maximum concentration of 100ppm.

The signature below verifies that statements above, including but not limited to any material composition data are, to the best of our knowledge, valid and accurate.

Edwin Bertotti
Manager, ECO-Products
Sustainability
NXP Semiconductors